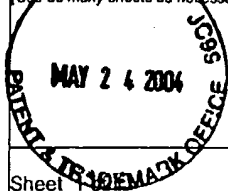


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Sheet 1

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|----------------------|---------------|
| Application Number | 10/612834 |
| Filing Date | June 30, 2003 |
| First Named Inventor | Dani, Ashay |
| Group Art Unit | 3743 |
| Examiner Name | Unknown |

Attorney Docket No: 884.945US1

US PATENT DOCUMENTS

| Examiner Initial * | USP Document Number | Publication Date | Name of Patentee or Applicant of cited Document | Class | Subclass | Filing Date If Appropriate |
|--------------------|---------------------|------------------|-------------------------------------------------|-------|----------|----------------------------|
| <i>MM</i> | US-6,504,242 | 01/07/2003 | Deppisch, Carl L., et al. | 257 | 707 | 11/15/2001 |

FOREIGN PATENT DOCUMENTS

| Examiner Initials* | Foreign Document No | Publication Date | Name of Patentee or Applicant of cited Document | Class | Subclass | T ² |
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OTHER DOCUMENTS -- NON PATENT LITERATURE DOCUMENTS

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|--------------------|----------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------|
| <i>MM</i> | | CHANG, CHIN-AN, "Enhanced Cu-Teflon adhesion by presputtering treatment: Effect of surface morphology changes", <u>Applied Physics Letters</u> , 51(16), (October 19, 1987), 1236-1238 | |
| <i>MM</i> | | PERRINS, L E., et al., "Mechanism for the adhesion of electroplated copper to polypropylene", <u>Plastics and Polymers</u> , 39(144), (December 1971), 391-397 | |

EXAMINER

DATE CONSIDERED

8-24-04

Substitute Disclosure Statement Form (PTO-1449)

* EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 608. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. Applicant's unique citation designation number (optional) : Applicant is to place a check mark here if English language Translation is attached